EVERLIGHT EVERLIGHT ELECTRONICS CO.,LTD.

Technical Data Sheet

1206 Package Chip LEDs

15-21SDRC/S530-XX/TR8

Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS complaint version.

Descriptions

- The 15-21 SMD Taping is much smaller than lead frame type components, thus smaller board size, higher packingdensity, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

| D. AN | | T. C.1 | |
|-----------------------|----------|----------------------|-------------|
| Part No. | Material | Emitted Color | Lens Color |
| 15-21SDRC/S530-XX/TR8 | AlGaInP | Deep- Red | Water Clear |



Everlight Electronics Co., Ltd. Device No:SZDSE-151-026

http://www.everlight.com

Prepared by: Meng Yali

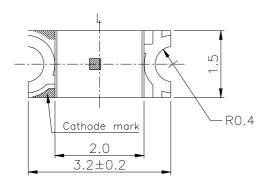
Page: 1 of 9

Rev 1

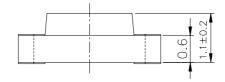
Prepared date: 19-Aug-2005



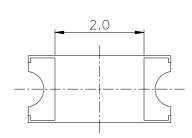
Package Outline Dimensions

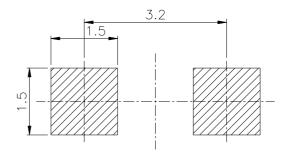






For reflow soldering (propose)





Note: Tolerances Unless Dimension is ± 0.1 mm, Unit = mm

Everlight Electronics Co., Ltd. Device No:SZDSE-151-026

http://www.everlight.com Prepared date: 19-Aug-2005 Rev 1

Page: 2 of 9

Prepared by: Meng Yali



EVERLIGHT ELECTRONICS CO.,LTD.

15-21SDRC/S530-XX/TR8

Absolute Maximum Ratings (Ta=25°C)

| Parameter | Symbol | Rating | Unit | |
|--|--------|---|--|--|
| Reverse Voltage | VR | 5 | V | |
| Forward Current | IF | 25 | mA | |
| Operating Temperature | Topr | -40 ~ +85 | ${\mathbb C}$ | |
| Storage Temperature | Tstg | -40~ +90 | $^{\circ}\!$ | |
| Electrostatic Discharge(HBM) | ESD | 2000 | V | |
| Power Dissipation | Pd | 60 | mW | |
| Peak Forward Current (Duty 1/10 @1KHz) | IF | 60 | mA | |
| Soldering Temperature | Tsol | Reflow Soldering: 260 °C for 10 sec. Hand Soldering: 350 °C for 3 sec. | | |

Electro-Optical Characteristics (Ta=25°C)

| Parameter | Symbol | *Chip Rank | Min. | Тур. | Max. | Unit | Condition |
|------------------------------|--------------|---------------|------|------|------|------|--------------------|
| Luminous Intensity | | A2 | 16 | 23 | | | |
| | | A3 | 26 | 33 | | | |
| | Iv | A4 | 31 | 40 | | mcd | |
| | | A5 | 42 | 52 | | deg | IF=20mA |
| | | A6 | 52 | 65 | | | |
| Viewing Angle | 2 \theta 1/2 | | | 130 | | | |
| Peak Wavelength | λp | | | 650 | | | |
| Dominant Wavelength | λd | | | 639 | | nm | |
| Spectrum Radiation Bandwidth | Δλ | | | 20 | | nm | |
| Forward Voltage | VF | | 1.7 | 2.0 | 2.4 | V | |
| Reverse Current | Ir | | | | 10 | μΑ | V _R =5V |

*15-21SDRC/S530<u>-XX/</u>TR8



Chip Rank

Everlight Electronics Co., Ltd.

Device No:SZDSE-151-026

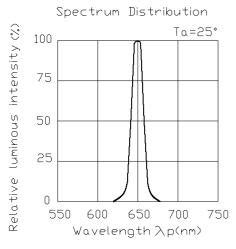
http://www.everlight.com

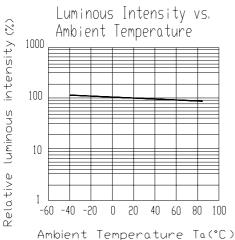
Rev 1 Page: 3 of 9

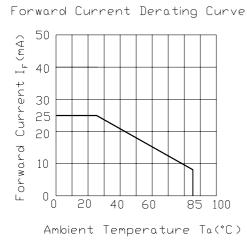
Prepared date: 19-Aug-2005

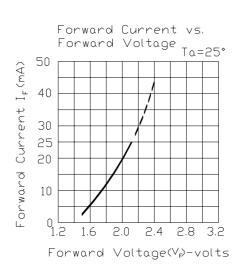
Prepared by: Meng Yali

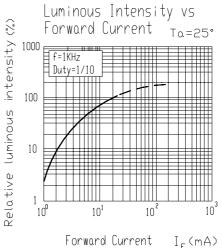
Typical Electro-Optical Characteristics

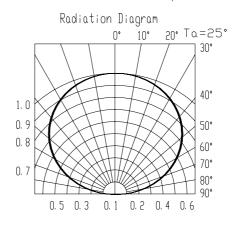












Rev 1

Label explanation

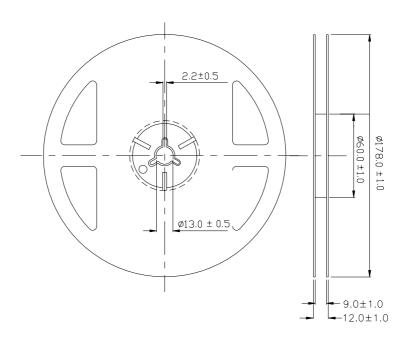
CAT: Luminous Intensity Rank

HUE: Dom. Wavelength Rank

REF: Forward Voltage Rank



Reel Dimensions

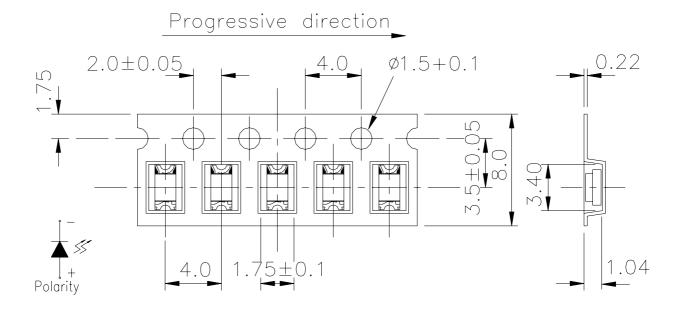


Note: The tolerances unless mentioned are ± 0.1 , Unit = mm.

http://www.everlight.com

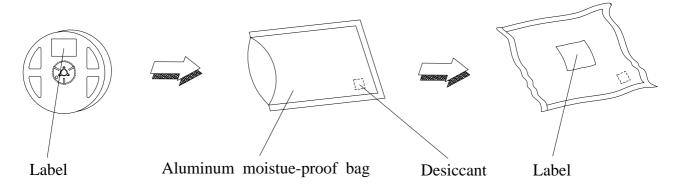
Rev 1

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: Tolerances Unless Dimension is ± 0.1 mm, Unit = mm

Moisture Resistant Packaging



Everlight Electronics Co., Ltd.

Device No:SZDSE-151-026

http://www.everlight.com Prepared date: 19-Aug-2005

Rev 1

Prepared by: Meng Yali

Page: 6 of 9

Reliability Test Items And Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

| No. | Items | Test Condition | Test Hours/Cycles | Sample Size | Ac/Re |
|-----|-------------------------------------|---|----------------------|----------------|-------|
| 1 | Reflow Soldering | Temp. : 260°C±5°C 5 sec. | 6 Min. | 22 Pcs. | 0/1 |
| 2 | Temperature Cycle | $H: +100^{\circ}\mathbb{C}$ 15min \int 5 min $L: -40^{\circ}\mathbb{C}$ 15min | 300 Cycles | 22 PCS. | 0/1 |
| 3 | Thermal Shock | $H: +100^{\circ}\mathbb{C}$ 5min $\int 10 \sec$ $L: -10^{\circ}\mathbb{C}$ 5min | 300 Cycles | 22 PCS. | 0/1 |
| 4 | High Temperature Storage | Temp. : 100°C | 1000 Hrs. | 22 PCS. | 0/1 |
| 5 | Low Temperature Storage | Temp. : -40°℃ | 1000 Hrs. | 22 PCS. | 0/1 |
| 6 | DC Operating Life | $I_F = 20 \text{ mA}$ | 1000 Hrs. | 22 PCS. | 0/1 |
| 7 | High Temperature / High Humidity | 85°C/85%RH | 1000 Hrs. | 22 PCS. | 0/1 |

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 1 Page: 7 of 9

Device No:SZDSE-151-026 Prepared date: 19-Aug-2005 Prepared by: Meng Yali

Precautions For Use

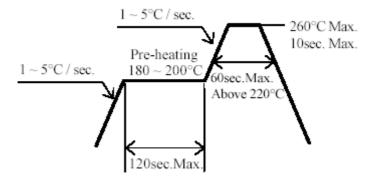
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 60%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment : $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 1 Page: 8 of 9

Device No:SZDSE-151-026 Prepared date: 19-Aug-2005 Prepared by: Meng Yali

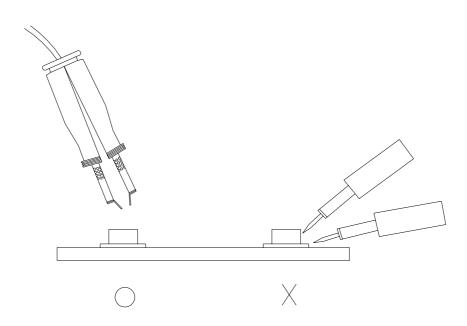


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



EVERLIGHT ELECTRONICS CO., LTD.

Office: No 25, Lane 76, Sec 3, Chung Yang Rd, Tucheng, Taipei 236, Taiwan, R.O.C Tel: 886-2-2267-2000, 2267-9936

Fax: 886-2267-6244, 2267-6189, 2267-6306

http://www.everlight.com

Everlight Electronics Co., Ltd. http://www.everlight.com Rev 1 Page: 9 of 9

Device No:SZDSE-151-026 Prepared date: 19-Aug-2005 Prepared by: Meng Yali